

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Takashi Hamada et al. Serial No: 10/051,064

Filed: January 18, 2002

Art Unit: 2823 Examiner: F. Toledo

For: SEMICONDUCTOR DEVICE

AND METHOD OF MANUFACTURING THE SAME

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on

September 16, 2003

Signature

Date September 16, 2003

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

## AMENDMENT A

Dear Sir:

In response to the Office Action dated May 20, 2003, please amend the above-identified application as follows.

09/24/2003 ANABII 00000094 10051064